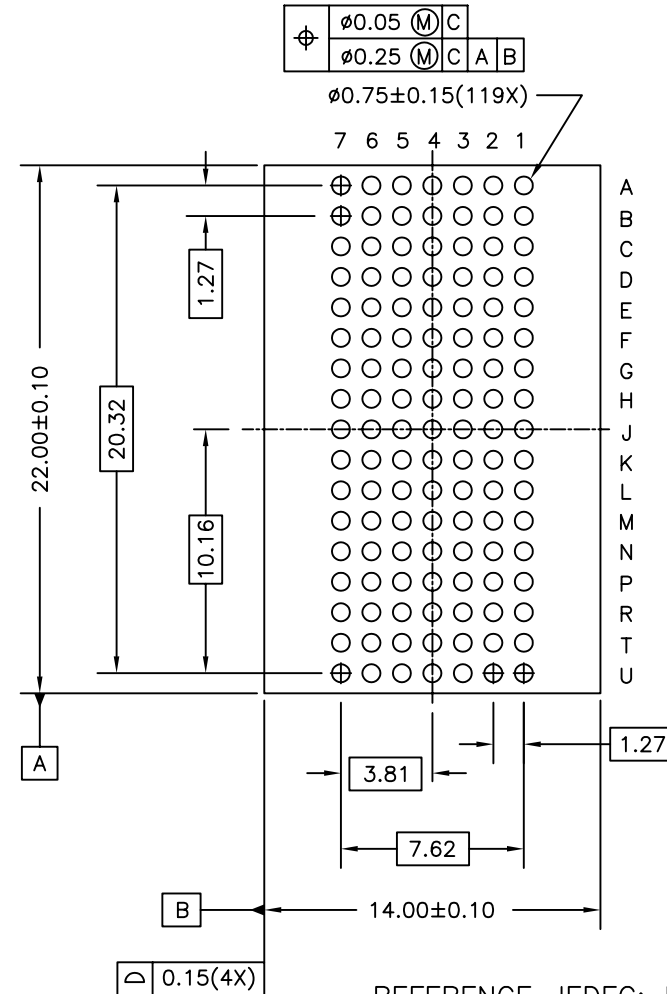
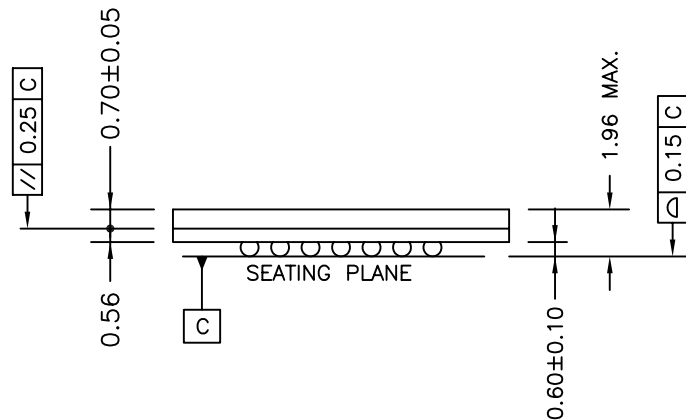
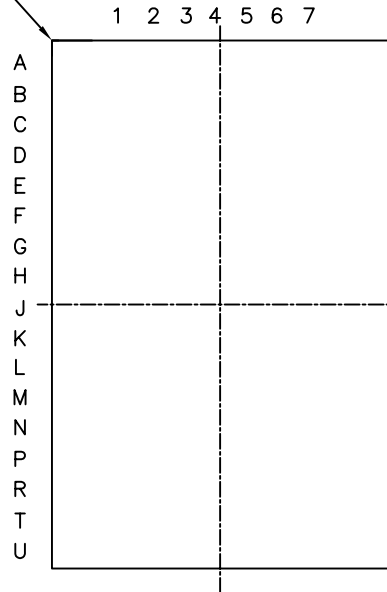



REVISIONS						
PAGE	ZONE	REV	ECN	DESCRIPTION	DATE	APPROVED
1	-	**	124784	NEW RELEASE	02/21/03	N/A
1	-	*A	226403	CHG. PKG. BODY TOLERANCE/ ADD PKG. WEIGHT	05/18/04	N/A
1	-	*B	2811236	Changed Template and Title from 119 FBGA (14x22x1.96mm) PKG. OUTL. to PACKAGE OUTLINE, 119L FBGA 14X22X1.96 MM BB119A.	11/19/09	QAD
1	-	*C	3351957	Update spec for sunset review, no changed	08/23/11	QAD
1	-	*D	3726298	Changed package weight reference from 1.1gms to "refer to PMDD spec"	08/28/12	QAD

A1 CORNER



REFERENCE JEDEC: N/A
PKG. WIEGHT: Refer to PMDD spec.

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UNLESS OTHERWISE SPECIFIED ALL DIMENSIONS ARE IN MILLIMETERS STANDARD TOLERANCES ARE: DECIMALS .XX ± 0.05 .XXX ± .XXXX + ANGLES ± 1°		DESIGNED BY HTN	DATE 05/18/04	 CYPRESS Company Confidential	
		DRAWN BY HTN	DATE 05/18/04		
		CHECKED BY XANC	DATE 08/28/12		
		APPROVED BY QAD	DATE 08/28/12		
MATERIAL N/A		APPROVED BY EDCA	DATE 08/28/12	TITLE PACKAGE OUTLINE, 119L FBGA 14X22X1.96 MM BB119A	
FINISH N/A		APPROVED BY PRC	DATE 08/28/12	SIZE A	PART NO. BB119A
				DWG NO 51-85181	REV *D
				SCALED TO FIT N/A	SHEET 1 OF 1